

### GENERAL DESCRIPTION

The ME2302 is the N-Channel logic enhancement mode power field effect transistors, using high cell density, DMOS trench technology.

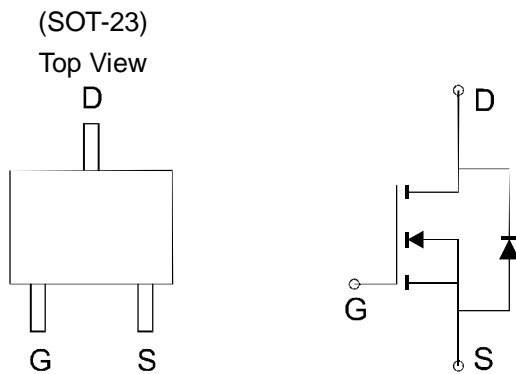
This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone, notebook computer power management and other battery powered circuits, and low in-line power loss that are needed in a very small outline surface mount package.

### ORDER INFORMATION

Device	Package
ME2302	SOT-23

### PIN CONFIGURATION



### FEATURES

- $R_{DS(ON)} \leq 85m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} \leq 115m\Omega @ V_{GS}=2.5V$
- $R_{DS(ON)} \leq 135m\Omega @ V_{GS}=1.8V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

### APPLICATIONS

- Power Management in Notebook
- Portable Equipment
- Load Switch
- DSC

### PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

### Absolute Maximum Ratings ( $T_A=25^\circ C$ Unless Otherwise Noted)

Parameter	Symbol	5 sec	Steady State	Unit
Drain-Source Voltage	$V_{DSS}$	20		V
Gate-Source Voltage	$V_{GSS}$	$\pm 8$		V
Continuous Drain Current ( $t_J=150^\circ C$ )	$I_D$	$T_A=25^\circ C$	2.8	A
		$T_A=70^\circ C$	2.2	
Pulsed Drain Current	$I_{DM}$	10		
Maximum Body-Diode Continuous Current	$I_S$	1.6		A
Maximum Power Dissipation	$P_D$	$T_A=25^\circ C$	1.25	W
		$T_A=70^\circ C$	0.8	
Operating Junction Temperature	$T_J$	150		$^\circ C$
Maximum Junction-to-Ambient	$R_{thJA}$	$T \leq 10$ sec	77	$^\circ C/W$
		Steady State	105	
Thermal Resistance-Junction to Case	$R_{\theta JC}$	70		$^\circ C/W$

\*The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper

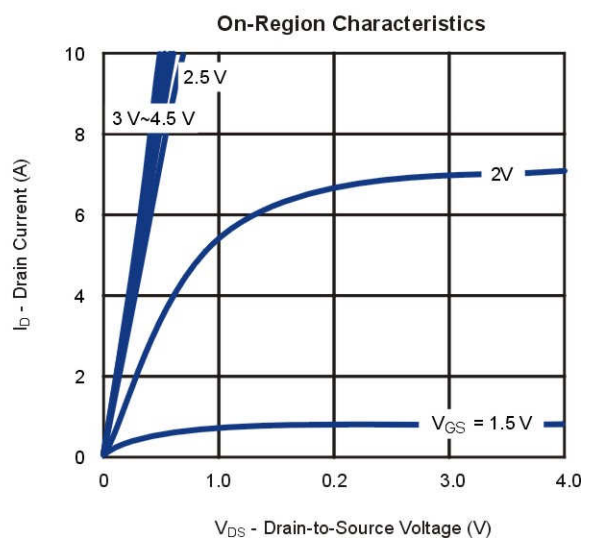
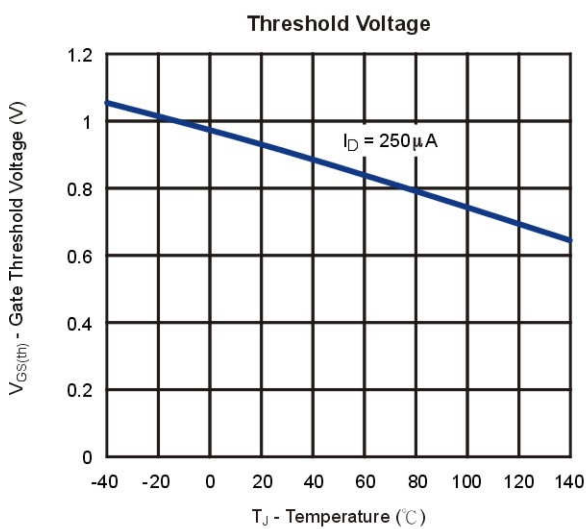
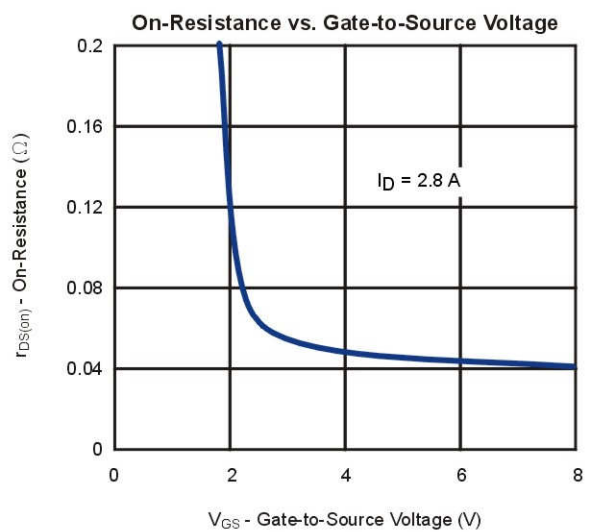
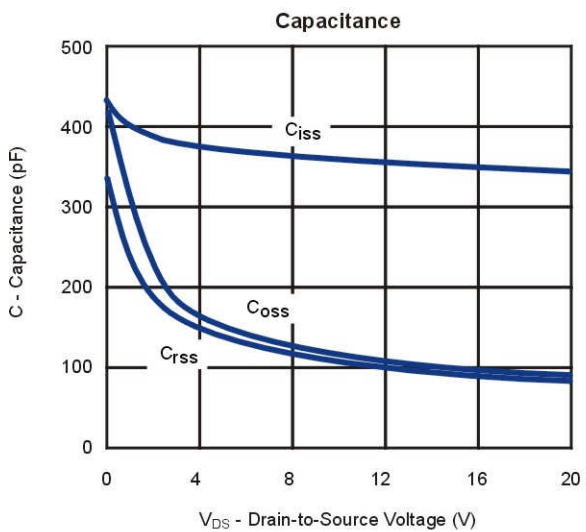
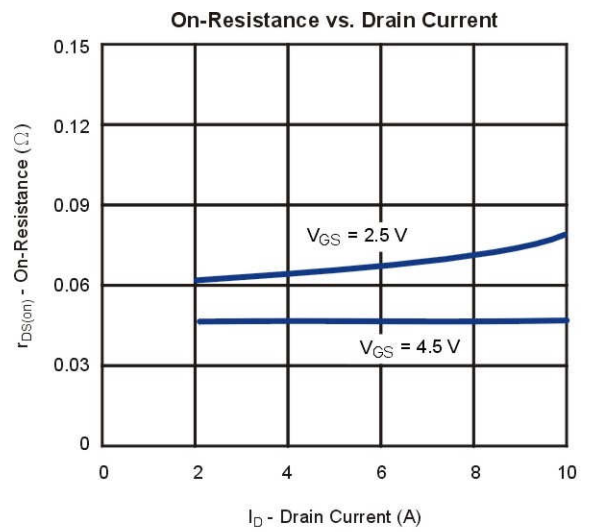
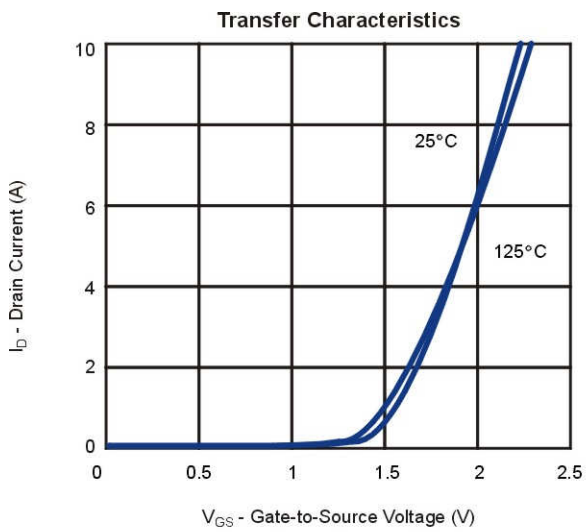
**Electrical Characteristics** (T<sub>A</sub>=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250 μA	20			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA	0.6	0.9	1.2	
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
		V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			10	
		T <sub>J</sub> =55°C				
I <sub>D(ON)</sub>	On-State Drain Current <sup>a</sup>	V <sub>DS</sub> ≥ 5V, V <sub>GS</sub> = 4.5V	6			A
		V <sub>DS</sub> ≥ 5V, V <sub>GS</sub> = 2.5V	4			
R <sub>DS(ON)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> = 2.8A		55	85	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> = 2.5A		65	115	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> = 2.2A		80	130	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =1A, V <sub>GS</sub> =0V		0.75	1.2	V
<b>DYNAMIC PARAMETERS</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =2.8A		9		nC
Q <sub>gs</sub>	Gate-Source Charge			2.2		
Q <sub>gd</sub>	Gate-Drain Charge			3		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHz		350		pF
C <sub>oss</sub>	Output Capacitance			90		
C <sub>rss</sub>	Reverse Transfer Capacitance			20		
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =10V, R <sub>L</sub> =10Ω V <sub>GEN</sub> =4.5Ω, R <sub>G</sub> =6Ω		9		ns
t <sub>r</sub>	Rise Time			23		
t <sub>d(off)</sub>	Turn-Off Delay Time			38		
t <sub>f</sub>	Fall Time			3		

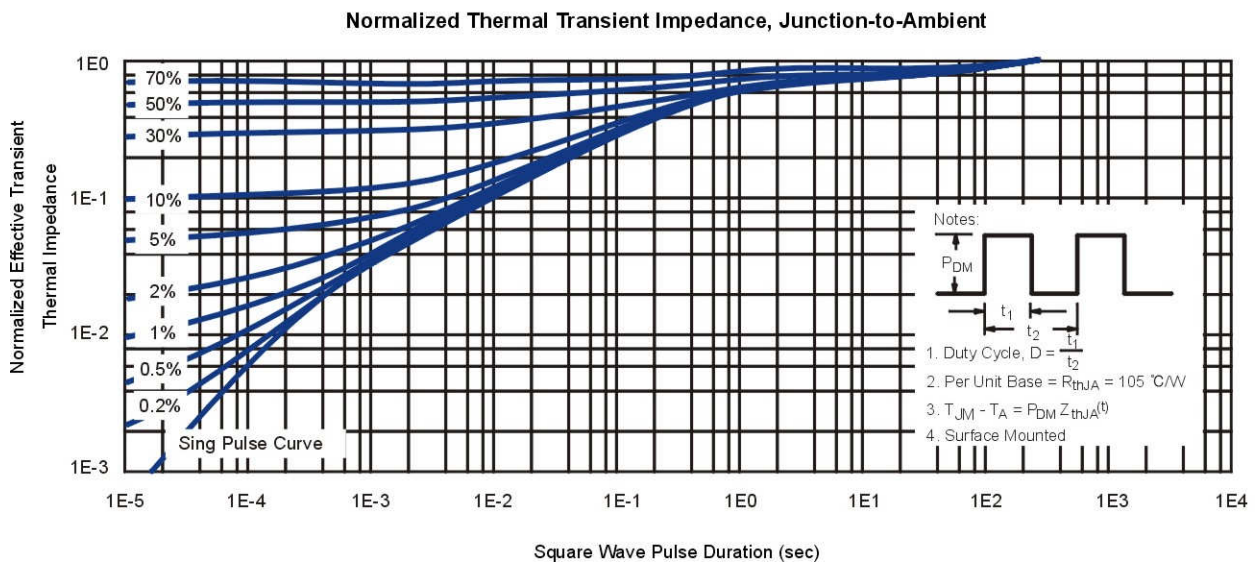
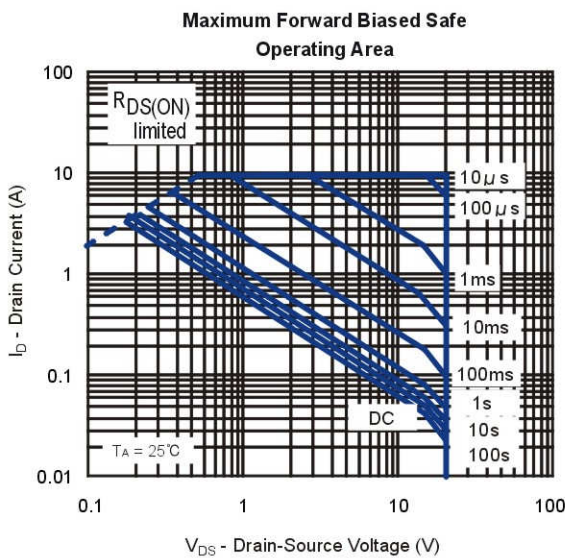
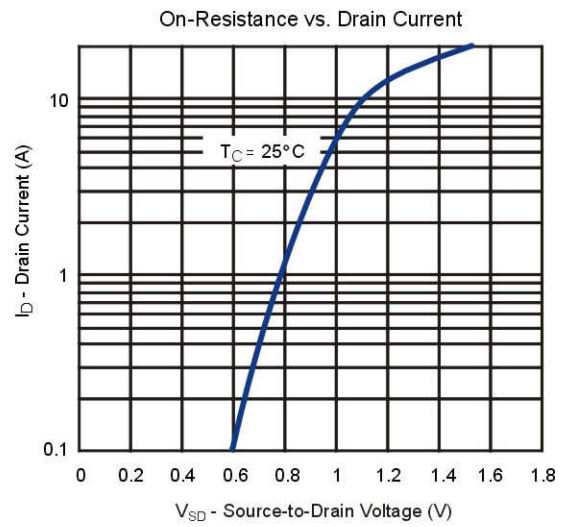
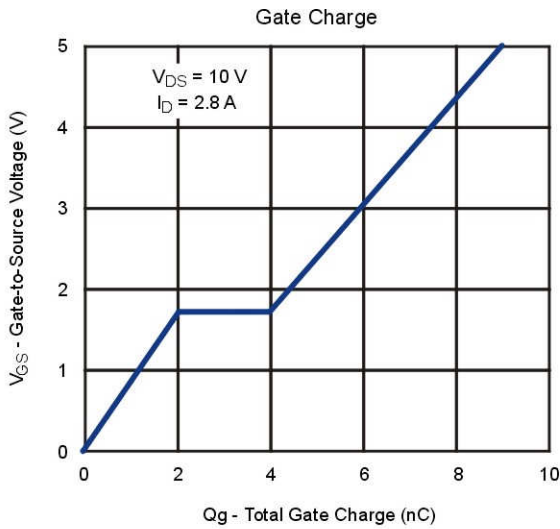
Notes:

a. Pulse test; pulse width ≤ 300us, duty cycle ≤ 2%

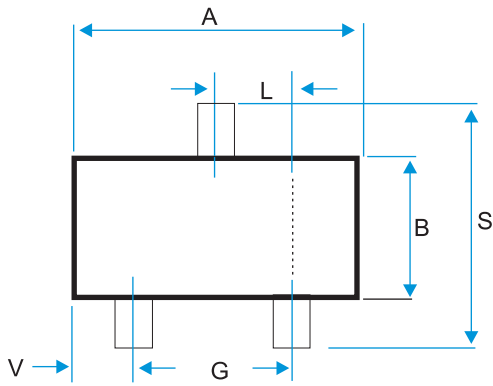
## Typical Characteristics (T<sub>J</sub> = 25°C Noted)



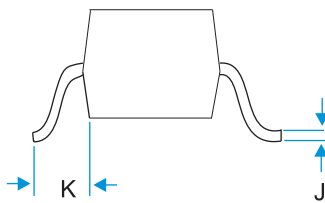
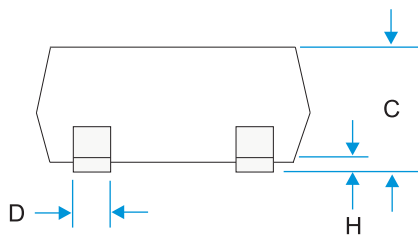
## Typical Characteristics (T<sub>J</sub> = 25°C Noted)



**SOT-23 Package Outline**



DIM	MILLIMETERS	
	MIN	MAX
A	2.80	3.1
B	1.20	1.7
C	0.89	1.3
D	0.37	0.50
G	1.78	2.04
H	0.013	0.15
J	0.085	0.2
K	0.45	0.7
L	0.89	1.02
S	2.10	3
V	0.45	0.60



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